

TRENCHSTOP™ IGBT6

IGBT in trench and field-stop technology with soft, fast recovery anti-parallel Rapid diode

Features and Benefits:

- Very low $V_{CE(sat)}$ 1.5V (typ.)
 - Maximum junction temperature 175°C
 - Short circuit withstand time 3μs
- Trench and field-stop technology for 650V applications offers :
- very tight parameter distribution
 - high ruggedness, temperature stable behavior
 - low V_{CEsat} and positive temperature coefficient
- Low gate charge Q_G
 - Pb-free lead plating; RoHS compliant
 - Very soft, fast recovery anti-parallel Rapid diode
 - Complete product spectrum and PSpice Models:
www.infineon.com/igbt

Potential Applications:

Drives

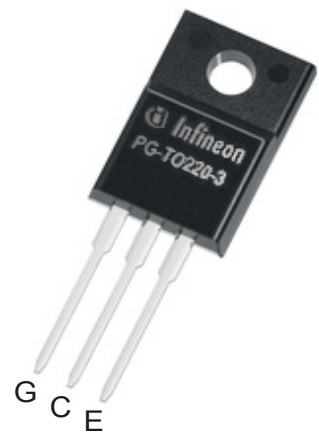
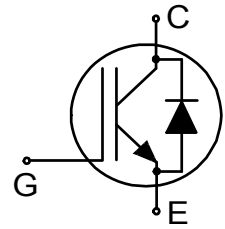
- GPD (general purpose drives)

Major home appliances

- Air conditioning
- Other major home appliances

Small home appliances

- Other small home appliances

**Key Performance and Package Parameters**

Type	V_{CE}	I_C	V_{CEsat} , $T_{vj}=25^\circ\text{C}$	T_{vjmax}	Marking	Package
IKA15N65ET6	650V	15A ¹⁾	1.5V ²⁾	175°C	K15EET6	PG-TO220-3 FP

¹⁾ Limited by maximum junction temperature. Applicable for TO-220 Standard package.

²⁾ Measured under conditions specified on page 4.



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Maximum Ratings

For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

Parameter	Symbol	Value	Unit
Collector-emitter voltage, $T_{vj} \geq 25^{\circ}\text{C}$	V_{CE}	650	V
DC collector current, limited by $T_{vjmax}^{1)}$ $T_c = 25^{\circ}\text{C}$ $T_c = 100^{\circ}\text{C}$	I_C	17.0 11.0	A
Pulsed collector current, t_p limited by T_{vjmax}	I_{Cpuls}	57.5	A
Turn off safe operating area $V_{CE} \leq 650\text{V}$, $T_{vj} \leq 175^{\circ}\text{C}$	-	57.5	A
Diode forward current, limited by $T_{vjmax}^{1)}$ $T_c = 25^{\circ}\text{C}$ $T_c = 100^{\circ}\text{C}$	I_F	17.0 10.0	A
Diode pulsed current, t_p limited by T_{vjmax}	I_{Fpuls}	57.5	A
Gate-emitter voltage Transient Gate-emitter voltage ($t_p \leq 10\mu\text{s}$, $D < 0.010$)	V_{GE}	± 20 ± 30	V
Short circuit withstand time $V_{GE} = 15.0\text{V}$, $V_{CC} \leq 360\text{V}$ Allowed number of short circuits < 1000 Time between short circuits: $\geq 1.0\text{s}$ $T_{vj} = 150^{\circ}\text{C}$	t_{SC}	3	μs
Power dissipation $T_c = 25^{\circ}\text{C}$ Power dissipation $T_c = 100^{\circ}\text{C}$	P_{tot}	45.0 22.0	W
Operating junction temperature	T_{vj}	$-40 \dots +175$	$^{\circ}\text{C}$
Storage temperature	T_{stg}	$-55 \dots +150$	$^{\circ}\text{C}$
Soldering temperature, wave soldering 1.6mm (0.063in.) from case for 10s		260	$^{\circ}\text{C}$
Mounting torque, M2.5 screw, PG-TO220-3 FP Maximum of mounting processes: 3	M	0.5	Nm
Isolation voltage RMS, $f = 50/60\text{Hz}$, $t = 1\text{min}$	V_{isol}	2500	V

Thermal Resistance

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	

 R_{th} Characteristics

IGBT thermal resistance, junction - case	$R_{th(j-c)}$		-	-	3.35	K/W
Diode thermal resistance, junction - case	$R_{th(j-c)}$		-	-	4.77	K/W
Thermal resistance junction - ambient	$R_{th(j-a)}$		-	-	65	K/W

¹⁾ Limited by maximum junction temperature. Applicable for TO220 standard package.

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Electrical Characteristic, at $T_{vj} = 25^{\circ}\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
Static Characteristic						
Collector-emitter breakdown voltage ¹⁾	V _{(BR)CES}	V _{GE} = 0V, I _C = 0.10mA	650	-	-	V
Collector-emitter saturation voltage	V _{CEsat}	V _{GE} = 15.0V, I _C = 11.5A	-	1.50	1.90	V
		T _{vj} = 25°C	-	1.65	-	
		T _{vj} = 125°C	-	-	-	
		T _{vj} = 175°C	-	1.75	-	
Diode forward voltage	V _F	V _{GE} = 0V, I _F = 11.5A	-	1.50	1.95	V
		T _{vj} = 25°C	-	1.48	-	
		T _{vj} = 125°C	-	-	-	
		T _{vj} = 175°C	-	1.43	-	
Gate-emitter threshold voltage	V _{GE(th)}	I _C = 0.20mA, V _{CE} = V _{GE}	4.8	5.6	6.4	V
Zero gate voltage collector current	I _{CES}	V _{CE} = 650V, V _{GE} = 0V	-	-	30	μA
		T _{vj} = 25°C	-	450	-	
		T _{vj} = 175°C				
Gate-emitter leakage current	I _{GES}	V _{CE} = 0V, V _{GE} = 20V	-	-	100	nA
Transconductance	g _{fs}	V _{CE} = 20V, I _C = 11.5A	-	11.6	-	S

Electrical Characteristic, at $T_{vj} = 25^{\circ}\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
Dynamic Characteristic						
Input capacitance	C _{ies}	V _{CE} = 25V, V _{GE} = 0V, f = 1MHz	-	1020	-	pF
Output capacitance	C _{oes}		-	50	-	
Reverse transfer capacitance	C _{res}		-	20	-	
Gate charge	Q _G	V _{CC} = 520V, I _C = 11.5A, V _{GE} = 15V	-	37.0	-	nC
Internal emitter inductance measured 5mm (0.197 in.) from case	L _E		-	7.0	-	nH
Short circuit collector current Max. 1000 short circuits Time between short circuits: ≥ 1.0s	I _{C(SC)}	V _{GE} = 15.0V, V _{CC} ≤ 360V, t _{SC} ≤ 3μs T _{vj} = 150°C	-	120	-	A

¹⁾ Measured with filter network.

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Switching Characteristic, Inductive Load

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
IGBT Characteristic, at $T_{vj} = 25^{\circ}\text{C}$						
Turn-on delay time	$t_{d(\text{on})}$	$T_{vj} = 25^{\circ}\text{C}$, $V_{CC} = 400\text{V}$, $I_C = 11.5\text{A}$, $V_{GE} = 0.0/15.0\text{V}$, $R_{G(\text{on})} = 47.0\Omega$, $R_{G(\text{off})} = 47.0\Omega$, $L_{\sigma} = 30\text{nH}$, $C_{\sigma} = 150\text{pF}$ L_{σ} , C_{σ} from Fig. E Energy losses include “tail” and diode reverse recovery.	-	30	-	ns
Rise time	t_r		-	22	-	ns
Turn-off delay time	$t_{d(\text{off})}$		-	117	-	ns
Fall time	t_f		-	42	-	ns
Turn-on energy	E_{on}		-	0.23	-	mJ
Turn-off energy	E_{off}		-	0.11	-	mJ
Total switching energy	E_{ts}		-	0.34	-	mJ

Diode Characteristic, at $T_{vj} = 25^{\circ}\text{C}$

Diode reverse recovery time	t_{rr}	$T_{vj} = 25^{\circ}\text{C}$, $V_R = 400\text{V}$, $I_F = 11.5\text{A}$, $di_F/dt = 400\text{A}/\mu\text{s}$	-	69	-	ns
Diode reverse recovery charge	Q_{rr}		-	0.21	-	μC
Diode peak reverse recovery current	I_{rrm}		-	5.1	-	A
Diode peak rate of fall of reverse recovery current during t_b	di_{rr}/dt		-	-265	-	$\text{A}/\mu\text{s}$

Switching Characteristic, Inductive Load

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
IGBT Characteristic, at $T_{vj} = 150^{\circ}\text{C}$						
Turn-on delay time	$t_{d(\text{on})}$	$T_{vj} = 150^{\circ}\text{C}$, $V_{CC} = 400\text{V}$, $I_C = 11.5\text{A}$, $V_{GE} = 0.0/15.0\text{V}$, $R_{G(\text{on})} = 47.0\Omega$, $R_{G(\text{off})} = 47.0\Omega$, $L_{\sigma} = 30\text{nH}$, $C_{\sigma} = 150\text{pF}$ L_{σ} , C_{σ} from Fig. E Energy losses include “tail” and diode reverse recovery.	-	27	-	ns
Rise time	t_r		-	23	-	ns
Turn-off delay time	$t_{d(\text{off})}$		-	135	-	ns
Fall time	t_f		-	67	-	ns
Turn-on energy	E_{on}		-	0.32	-	mJ
Turn-off energy	E_{off}		-	0.18	-	mJ
Total switching energy	E_{ts}		-	0.50	-	mJ

Diode Characteristic, at $T_{vj} = 150^{\circ}\text{C}$

Diode reverse recovery time	t_{rr}	$T_{vj} = 150^{\circ}\text{C}$, $V_R = 400\text{V}$, $I_F = 11.5\text{A}$, $di_F/dt = 400\text{A}/\mu\text{s}$	-	113	-	ns
Diode reverse recovery charge	Q_{rr}		-	0.50	-	μC
Diode peak reverse recovery current	I_{rrm}		-	8.0	-	A
Diode peak rate of fall of reverse recovery current during t_b	di_{rr}/dt		-	-228	-	$\text{A}/\mu\text{s}$

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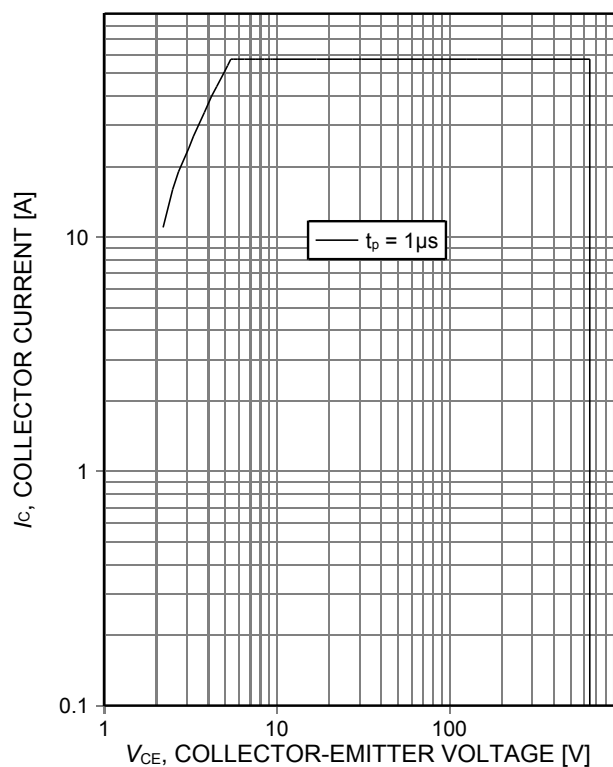


Figure 1. **Forward bias safe operating area**
($D=0$, $T_C=25^\circ\text{C}$, $T_{vj}\leq 175^\circ\text{C}$; $V_{GE}=15\text{V}$.
Recommended use at $V_{GE}\geq 15\text{V}$)

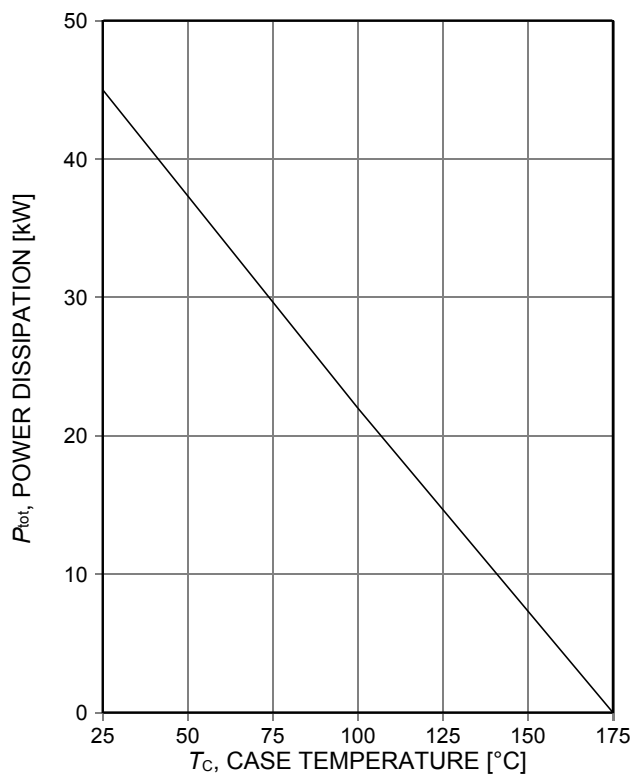


Figure 2. **Power dissipation as a function of case temperature**
($T_{vj}\leq 175^\circ\text{C}$)

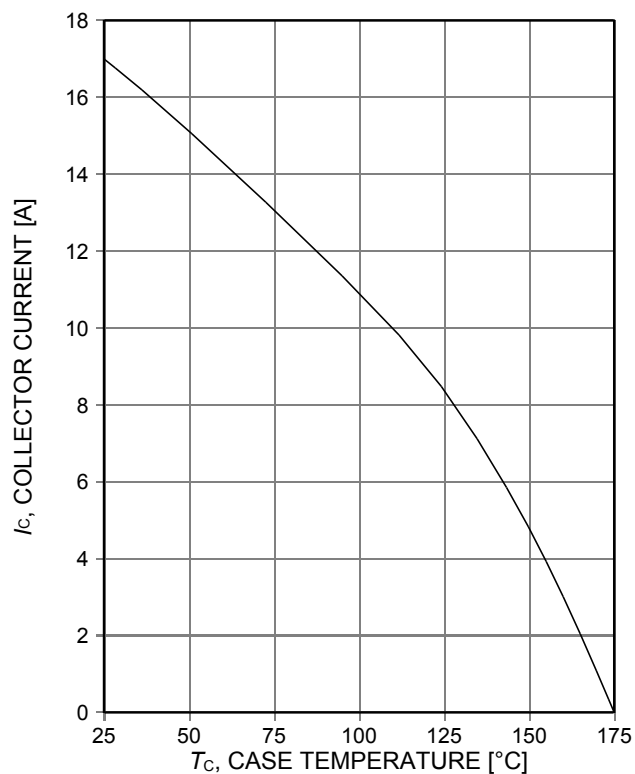


Figure 3. **Collector current as a function of case temperature**
($V_{GE}\geq 15\text{V}$, $T_{vj}\leq 175^\circ\text{C}$)

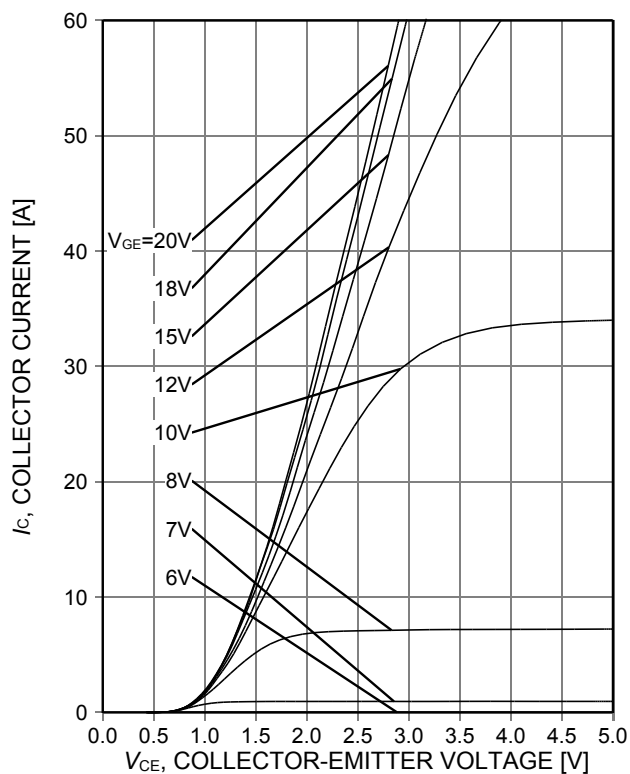


Figure 4. **Typical output characteristic**
($T_{vj}=25^\circ\text{C}$)

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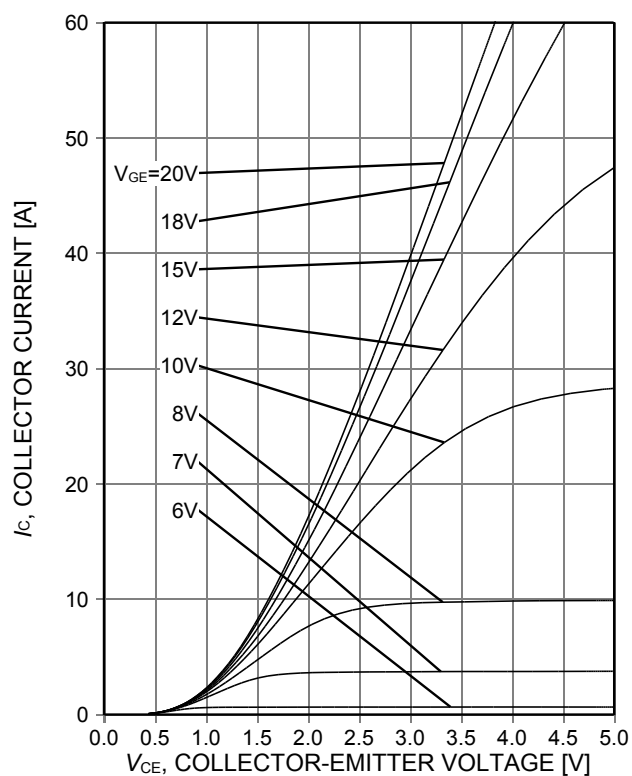


Figure 5. **Typical output characteristic**
($T_{vj}=150^{\circ}\text{C}$)

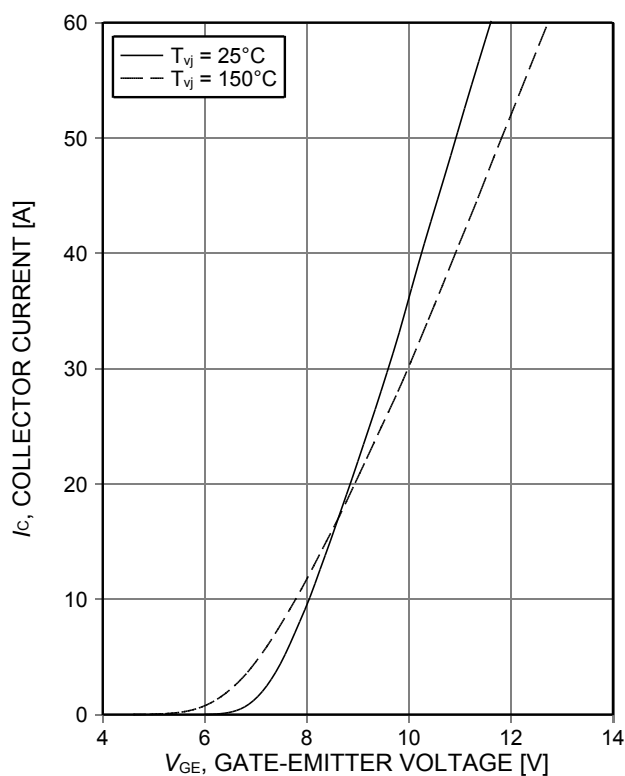


Figure 6. **Typical transfer characteristic**
($V_{CE}=50\text{V}$)

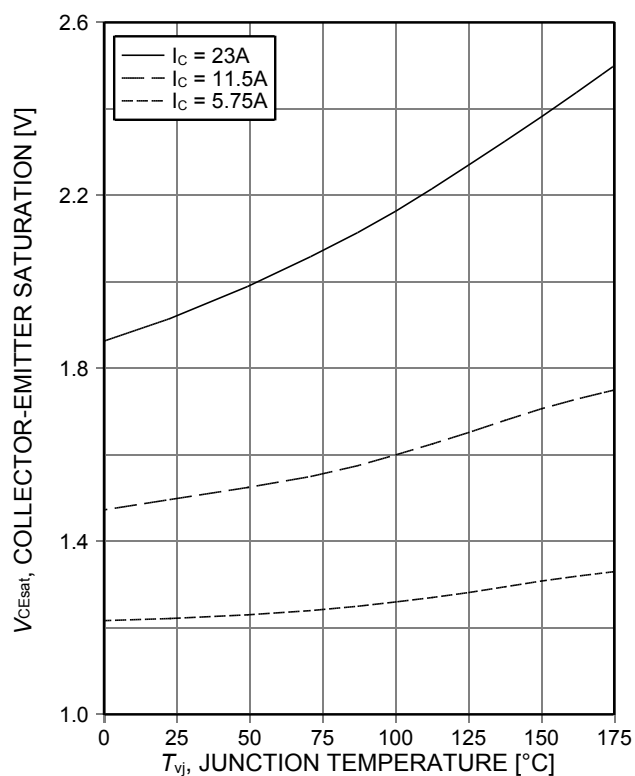


Figure 7. **Typical collector-emitter saturation voltage as a function of junction temperature**
($V_{GE}=15\text{V}$)

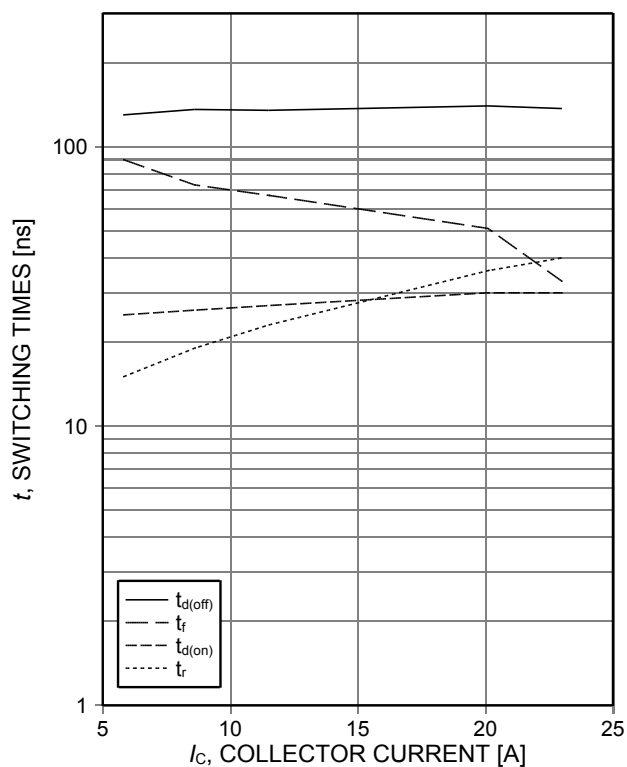


Figure 8. **Typical switching times as a function of collector current**
(inductive load, $T_{vj}=150^{\circ}\text{C}$, $V_{CE}=400\text{V}$, $V_{GE}=15/0\text{V}$, $r_G=47\Omega$, Dynamic test circuit in Figure E)

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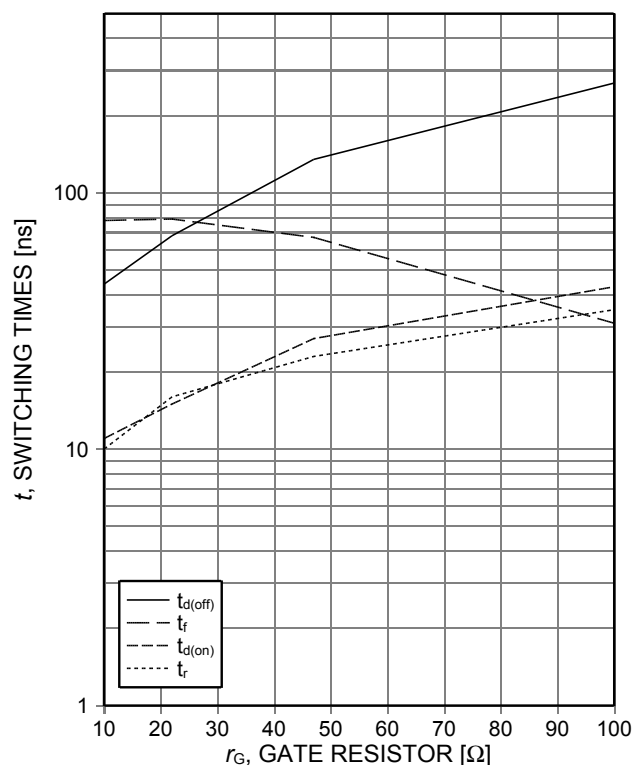


Figure 9. **Typical switching times as a function of gate resistor**
(inductive load, $T_{vj}=150^{\circ}\text{C}$, $V_{CE}=400\text{V}$, $V_{GE}=15/0\text{V}$, $I_C=11.5\text{A}$, Dynamic test circuit in Figure E)

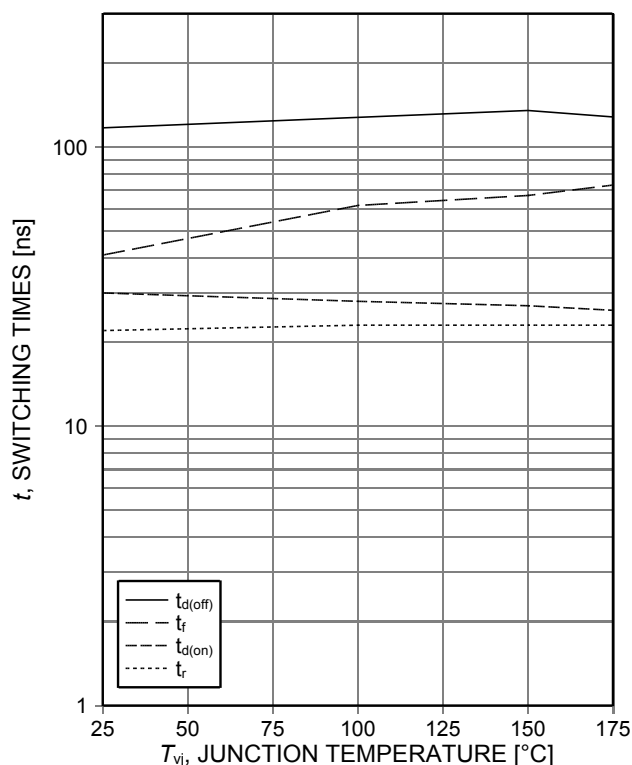


Figure 10. **Typical switching times as a function of junction temperature**
(inductive load, $V_{CE}=400\text{V}$, $V_{GE}=15\text{V}$, $I_C=11.5\text{A}$, $r_G=47\Omega$, Dynamic test circuit in Figure E)

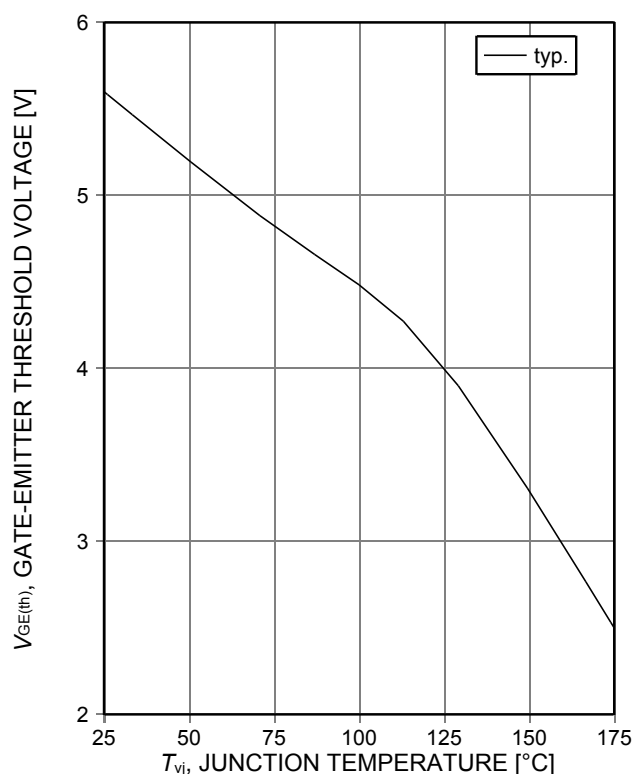


Figure 11. **Gate-emitter threshold voltage as a function of junction temperature**
($I_C=0.2\text{mA}$)

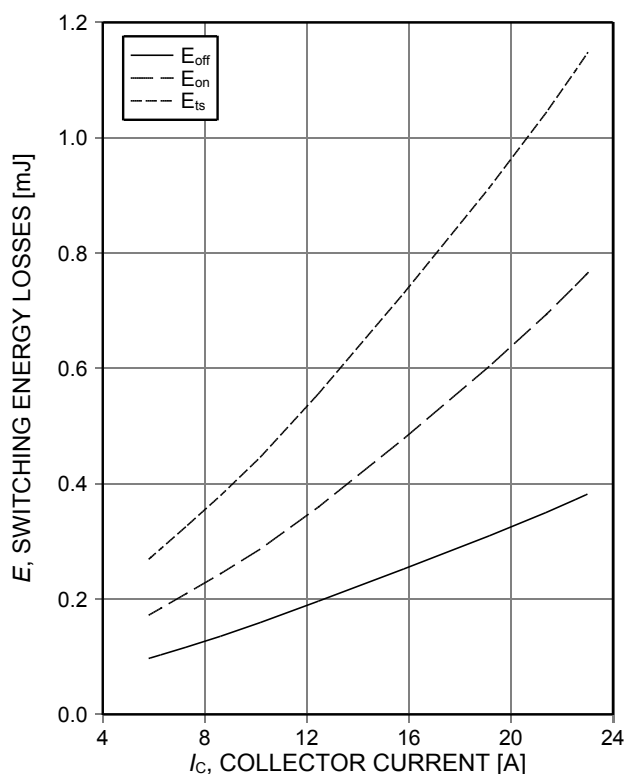


Figure 12. **Typical switching energy losses as a function of collector current**
(inductive load, $T_{vj}=150^{\circ}\text{C}$, $V_{CE}=400\text{V}$, $V_{GE}=15/0\text{V}$, $r_G=47\Omega$, Dynamic test circuit in Figure E)

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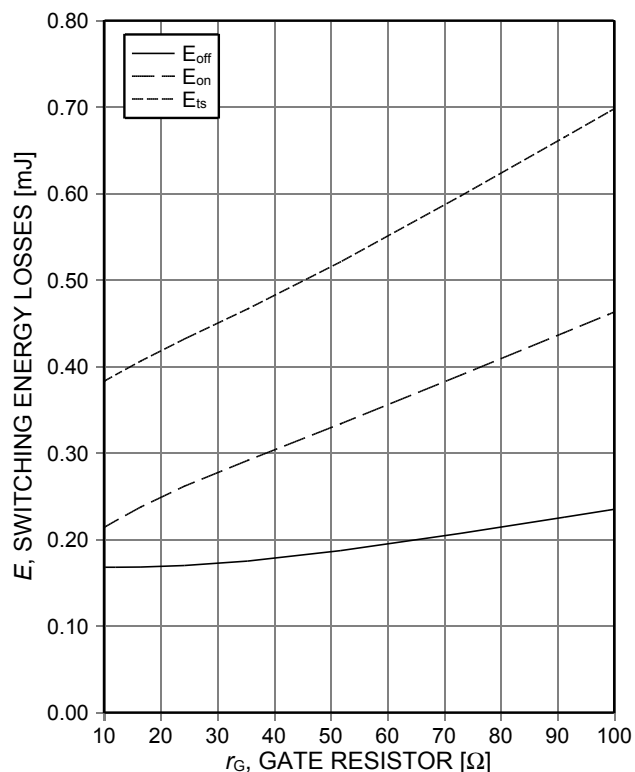


Figure 13. **Typical switching energy losses as a function of gate resistor**
(inductive load, $T_{vj}=150^{\circ}\text{C}$, $V_{CE}=400\text{V}$, $V_{GE}=15/0\text{V}$, $I_C=11.5\text{A}$, Dynamic test circuit in Figure E)

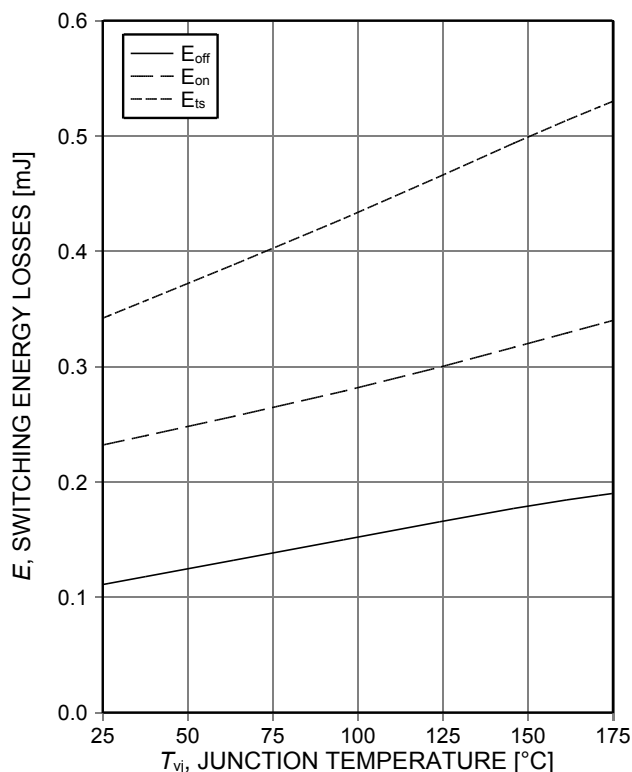


Figure 14. **Typical switching energy losses as a function of junction temperature**
(inductive load, $V_{CE}=400\text{V}$, $V_{GE}=15\text{V}$, $I_C=11.5\text{A}$, $r_G=47\Omega$, Dynamic test circuit in Figure E)

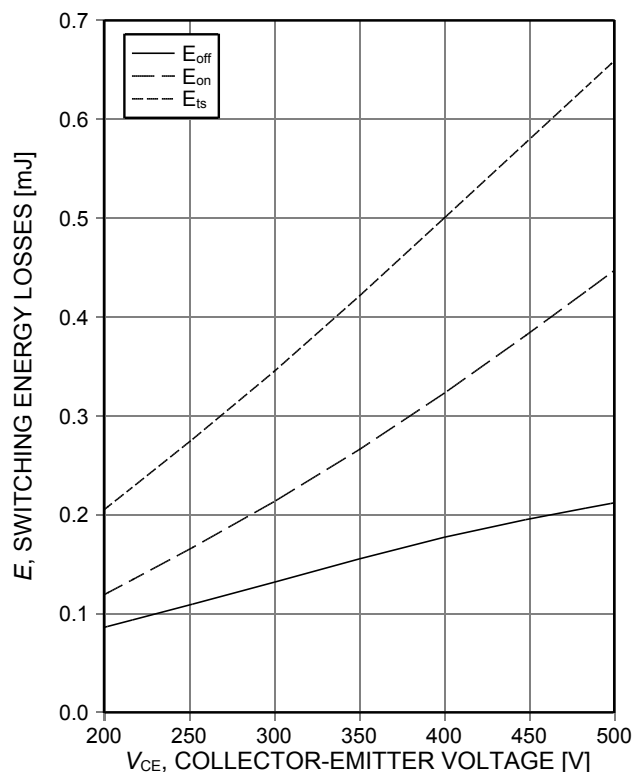


Figure 15. **Typical switching energy losses as a function of collector emitter voltage**
(inductive load, $T_{vj}=150^{\circ}\text{C}$, $V_{GE}=15/0\text{V}$, $I_C=11.5\text{A}$, $r_G=47\Omega$, Dynamic test circuit in Figure E)

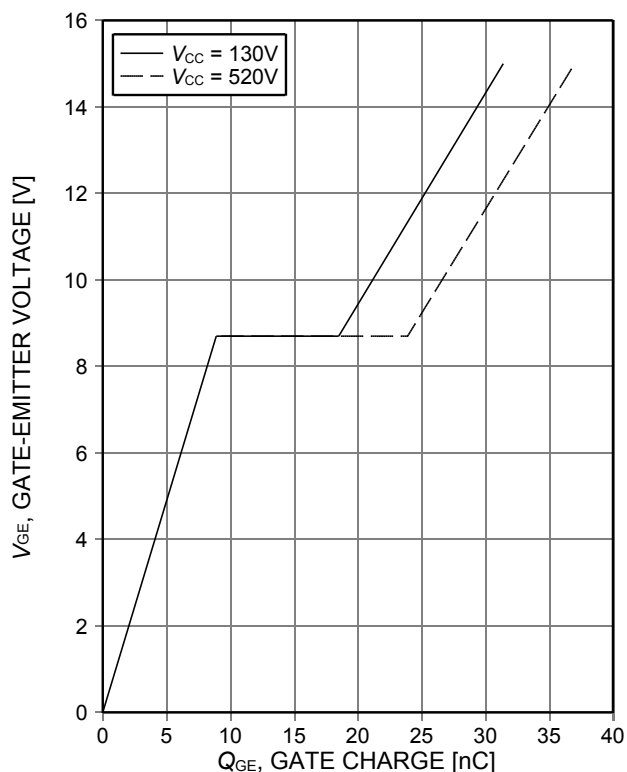


Figure 16. **Typical gate charge**
($I_C=11.5\text{A}$)

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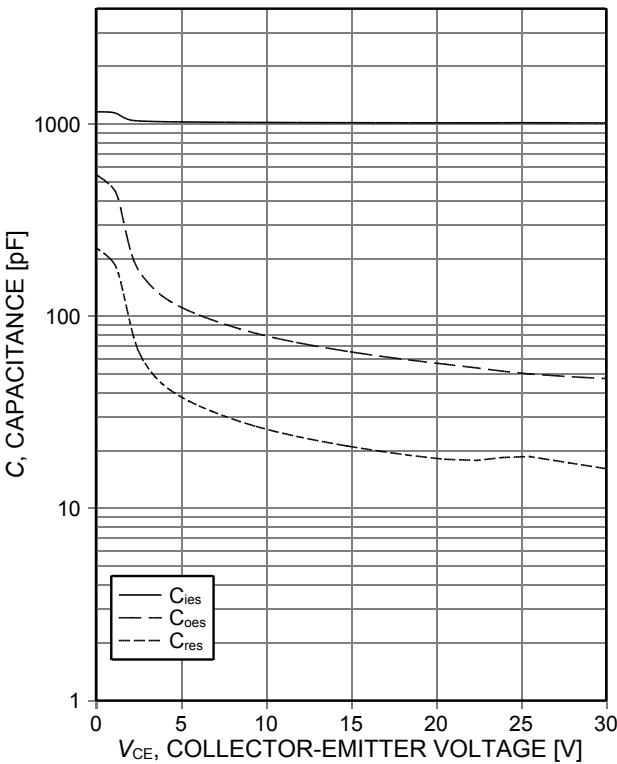


Figure 17. Typical capacitance as a function of collector-emitter voltage ($V_{GE}=0V$, $f=1MHz$)

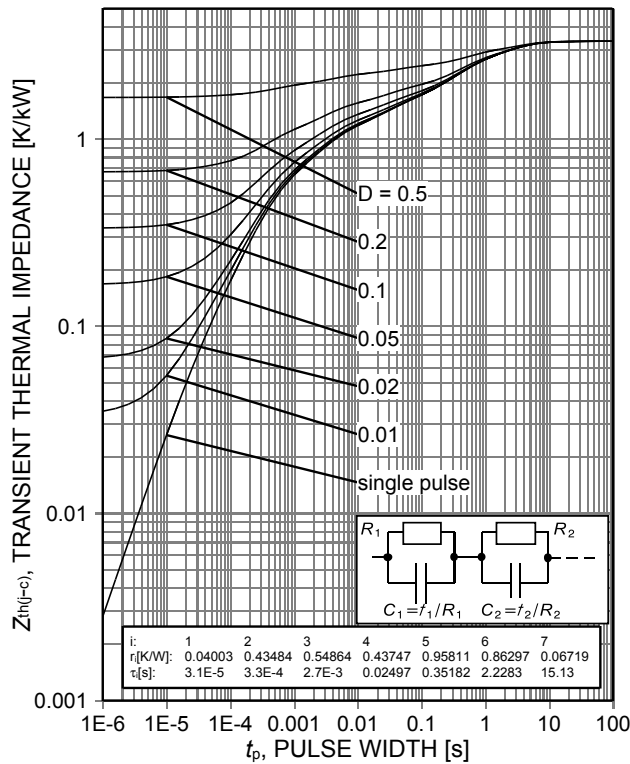


Figure 18. IGBT transient thermal impedance ($D=t_p/T$)

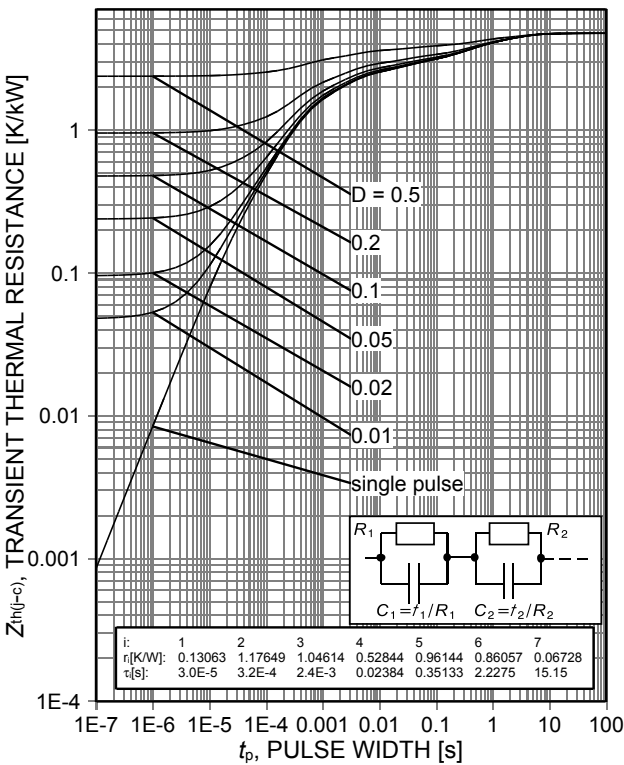


Figure 19. Diode transient thermal impedance as a function of pulse width ($D=t_p/T$)

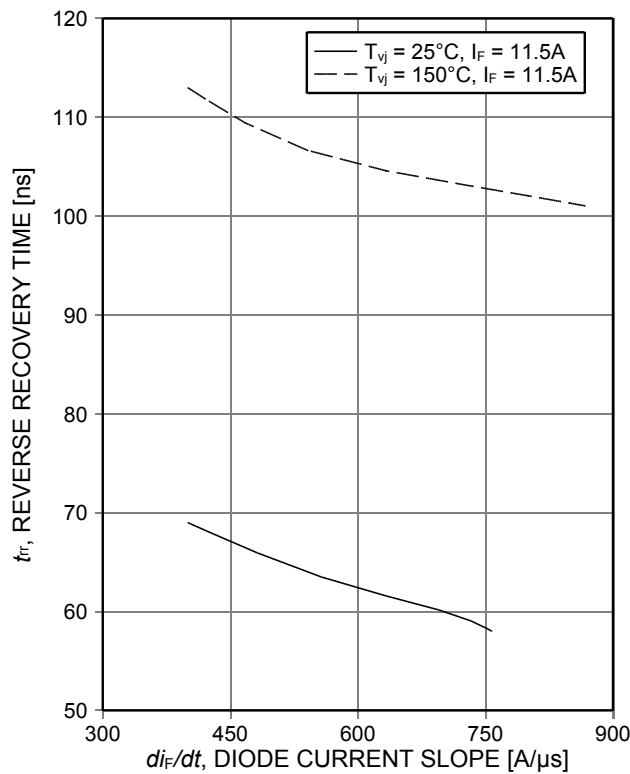


Figure 20. Typical reverse recovery time as a function of diode current slope ($V_R=400V$)

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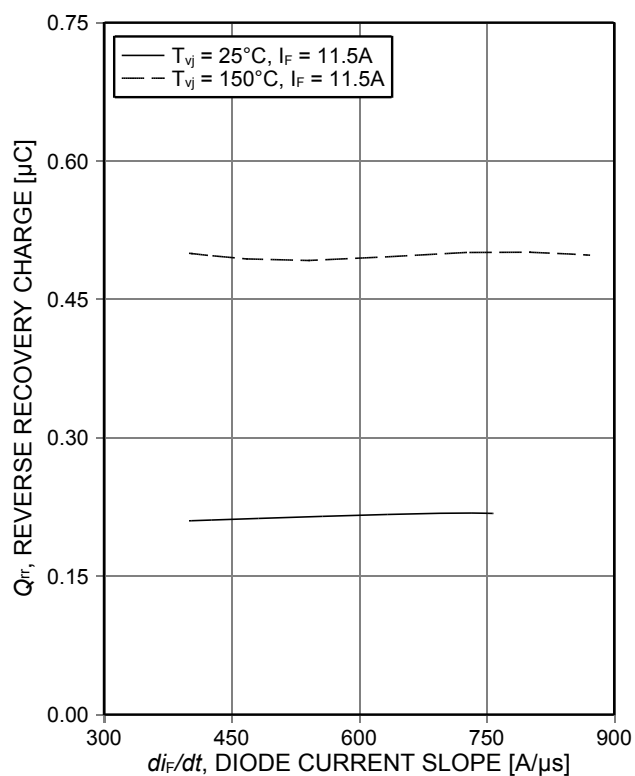


Figure 21. Typical reverse recovery charge as a function of diode current slope ($V_R=400V$)

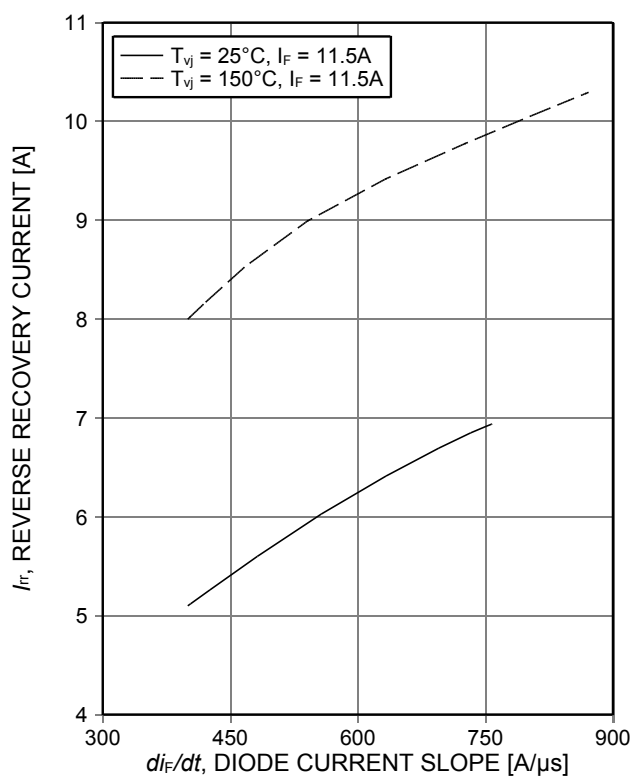


Figure 22. Typical reverse recovery current as a function of diode current slope ($V_R=400V$)

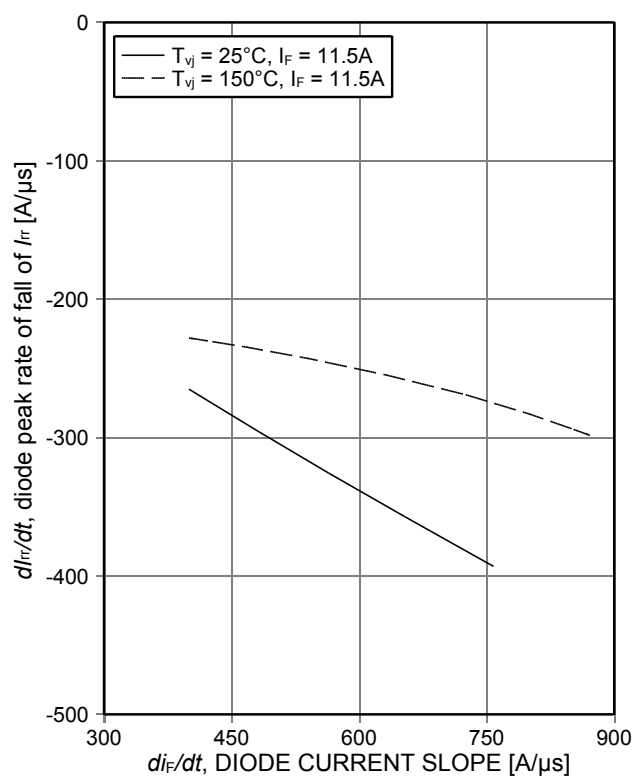


Figure 23. Typical diode peak rate of fall of reverse recovery current as a function of diode current slope ($V_R=400V$)

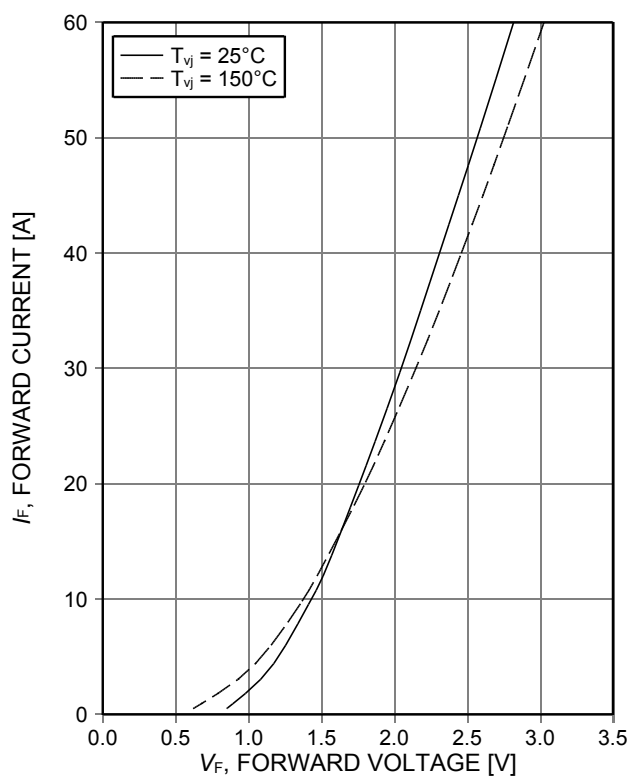


Figure 24. Typical diode forward current as a function of forward voltage

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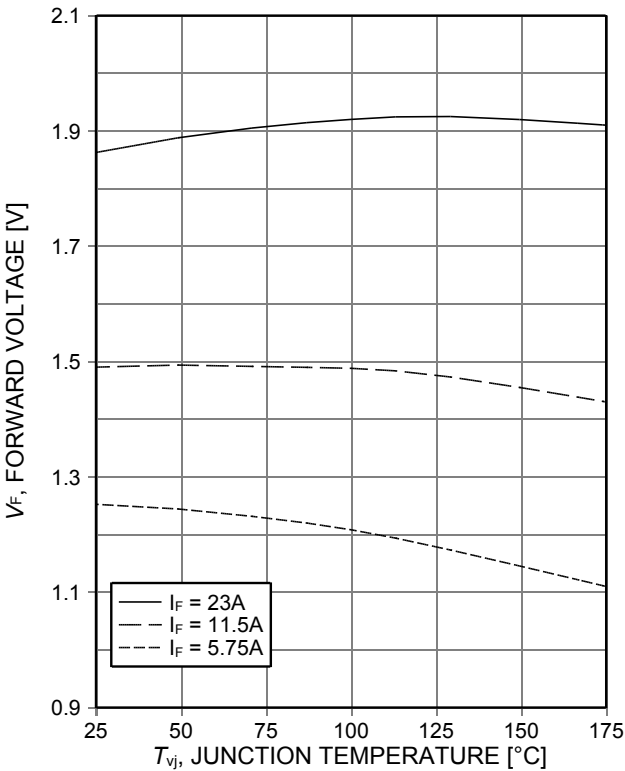
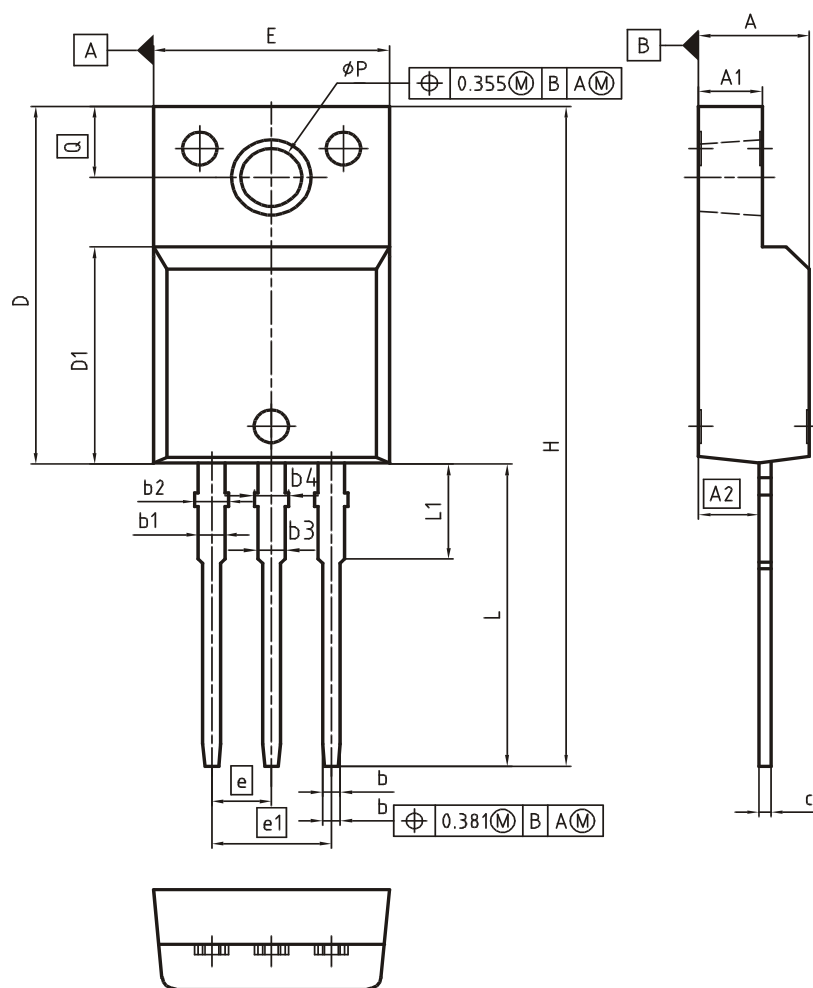


Figure 25. Typical diode forward voltage as a function of junction temperature

Package Drawing PG-TO220-3-FP



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.55	4.85	0.179	0.191
A1	2.55	2.85	0.100	0.112
A2	2.42	2.72	0.095	0.107
b	0.65	0.85	0.026	0.033
b1	0.95	1.33	0.037	0.052
b2	0.95	1.51	0.037	0.059
b3	0.65	1.33	0.026	0.052
b4	0.65	1.51	0.026	0.059
c	0.40	0.63	0.016	0.025
D	15.85	16.15	0.624	0.636
D1	9.53	9.83	0.375	0.387
E	10.35	10.65	0.407	0.419
e	2.54		0.100	
e1	5.08		0.200	
N	3		3	
H	29.45	29.75	1.159	1.171
L	13.45	13.75	0.530	0.541
L1	3.15	3.45	0.124	0.136
ØP	2.95	3.20	0.116	0.126
Q	3.15	3.50	0.124	0.138

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Testing Conditions



Figure A. Definition of switching times



Figure B. Definition of switching losses



Figure C. Definition of diode switching characteristics

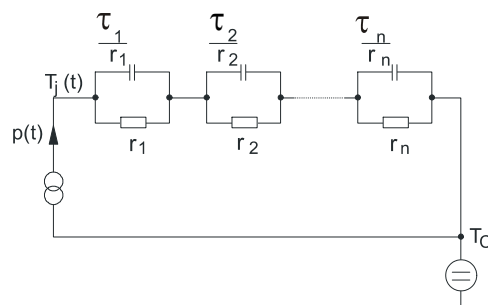


Figure D. Thermal equivalent circuit



Figure E. **Dynamic test circuit**
Parasitic inductance L_σ ,
parasitic capacitor C_σ ,
relief capacitor C_r ,
(only for ZVT switching)

TRENCHSTOP™ IGBT6**Revision History**

IKA15N65ET6**Revision: 2017-11-30, Rev. 2.2**

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.1	2017-09-11	Final Datasheet
2.2	2017-11-30	New Gfs Value at VCE=20V

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